



## DMP2040USS

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
-20V	$33m\Omega @ V_{GS} = -4.5V$	-7.0A
	$52m\Omega @ V_{GS} = -2.5V$	-5.5A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- **Power Management Functions**
- **DC-DC Converters**

# **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

P-CHANNEL ENHANCEMENT MODE MOSFET

Halogen and Antimony Free. "Green" Device (Note 3)

## **Mechanical Data**

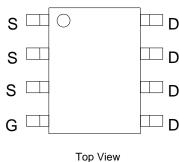
Case: SO-8

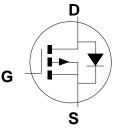
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- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.072g (Approximate)







Equivalent Circuit

## Ordering Information (Note 4)

Top View

Part Number	Case	Packaging
DMP2040USS-13	SO-8	2500/Tape & Reel

Pin-Out

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

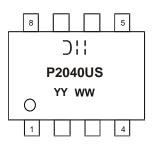
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**

Notes:



) | | = Manufacturer's Marking P2040US = Product Type Marking Code YYWW = Date Code Marking YY or  $\overline{YY}$ = Year (ex: 19 = 2019) WW = Week (01 to 53)



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DSS</sub>	-20	V		
Gate-Source Voltage	V <sub>GSS</sub>	±12	V		
Continuous Drain Current (Note 6) $V_{GS} = -4.5V$	Steady	T <sub>A</sub> = +25°C		-7.0	٨
	State	T <sub>A</sub> = +70°C	ID	-5.5	A
Continuous Drain Current (Note 7) $V_{GS}$ = -4.5V	Steady State	T <sub>C</sub> = +25°C	۱ <sub>D</sub>	-15	А
		T <sub>C</sub> = +70°C		-12	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	-30	А		
Continuous Source-Drain Diode Current (Note 6)			I <sub>S</sub>	-2.2	А
Avalanche Current (Note 8) L = 0.1mH			I <sub>AS</sub>	-16	А
Avalanche Energy (Note 8) L = 0.1mH			E <sub>AS</sub>	13.5	mJ

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>0JA</sub>	91	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	1.9	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R <sub>0JA</sub>	64	°C/W
Thermal Resistance, Junction to Case (Note 7)	Steady State	R <sub>0JC</sub>	13.5	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C	

# Electrical Characteristics (T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)			•			•	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-20	—	—	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	—	-1	μA	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	—	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)						-	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.6	—	-1.5	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	
Static Drain-Source On-Resistance	Deserve	_	26	33		$V_{GS} = -4.5V, I_D = -8.9A$	
Static Dram-Source On-Resistance	R <sub>DS(ON)</sub>	_	37.5	52	mΩ	$V_{GS} = -2.5V, I_D = -6.9A$	
Diode Forward Voltage	V <sub>SD</sub>	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -2.9A$	
DYNAMIC CHARACTERISTICS (Note 10)						-	
Input Capacitance	Ciss		834	—	pF	$V_{DS} = -10V, V_{GS} = 0V,$ f = 1.0MHz	
Output Capacitance	Coss	—	133	—			
Reverse Transfer Capacitance	C <sub>rss</sub>	_	105	—			
Gate Resistance	Rg	_	4.9	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V <sub>GS</sub> = -4.5V)	Qg	_	8.6	—			
Total Gate Charge (V <sub>GS</sub> = -8V)	Qg	_	19	—	nC	V <sub>DS</sub> = -6V, I <sub>D</sub> = -8.9A	
Gate-Source Charge	Q <sub>gs</sub>	_	1.5	—			
Gate-Drain Charge	Q <sub>gd</sub>	_	2.5	—			
Turn-On Delay Time	t <sub>D(ON)</sub>		5.8	—		$V_{DD} = -6V, R_L = 6\Omega$	
Turn-On Rise Time	t <sub>R</sub>		7.7	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>		28.1	_		$V_{GS}$ = -4.5V, $R_g$ = 6 $\Omega$ , $I_D$ = -1A	
Turn-Off Fall Time	tF	_	14.6	_			
Body Diode Reverse Recovery Time	t <sub>RR</sub>	_	9.8	—	ns	I <sub>F</sub> = -8.9A, di/dt = -100A/µs	
Body Diode Reverse Recovery Charge	Q <sub>RR</sub>	_	2.7	_	nC	I <sub>F</sub> = -8.9A, di/dt = -100A/µs	

Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).

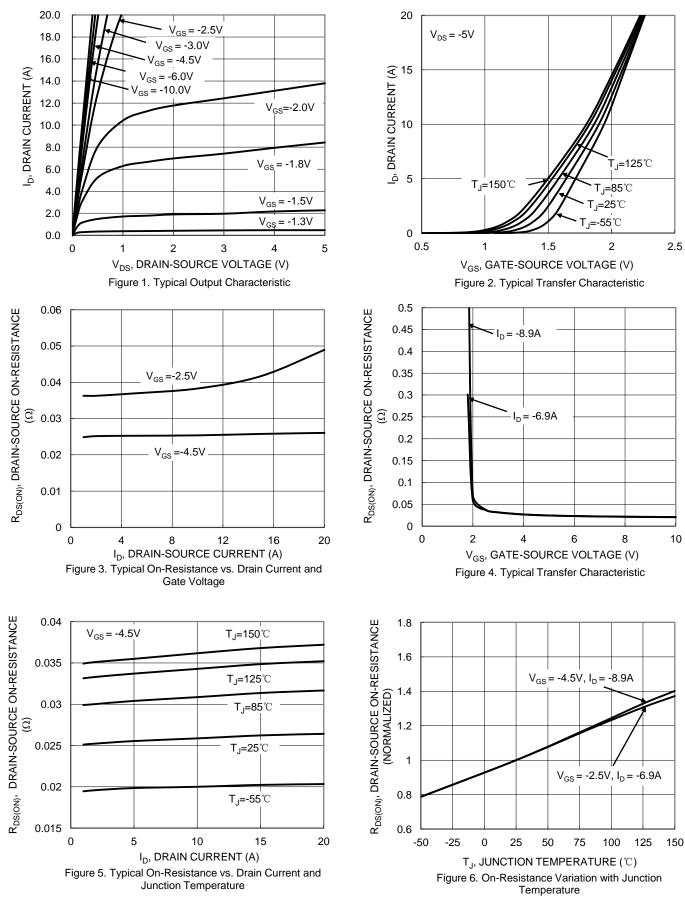
8. I<sub>AS</sub> and E<sub>AS</sub> ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.

9. Short duration pulse test used to minimize self-heating effect.

10. Guaranteed by design. Not subject to product testing.

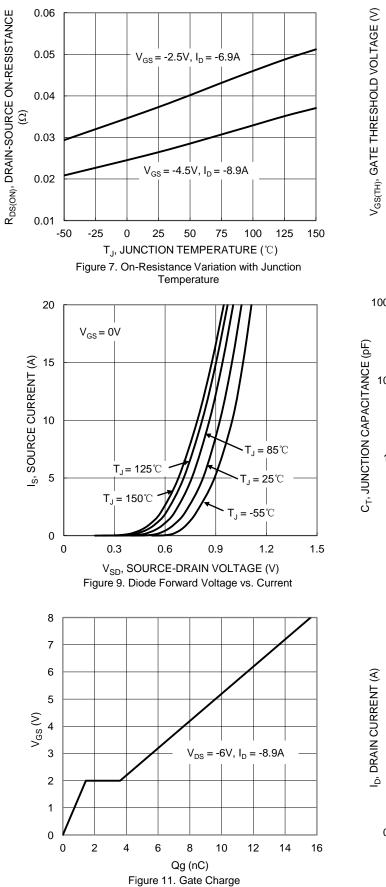


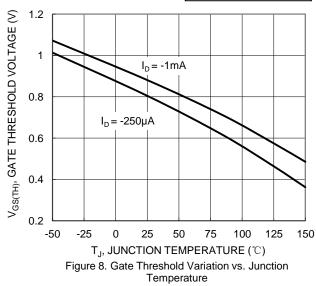
## DMP2040USS





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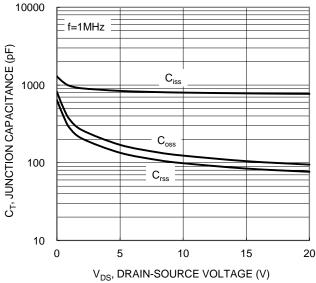
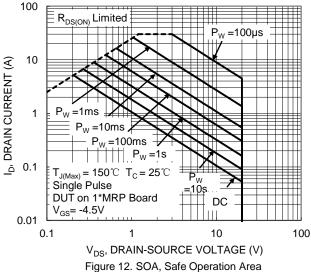
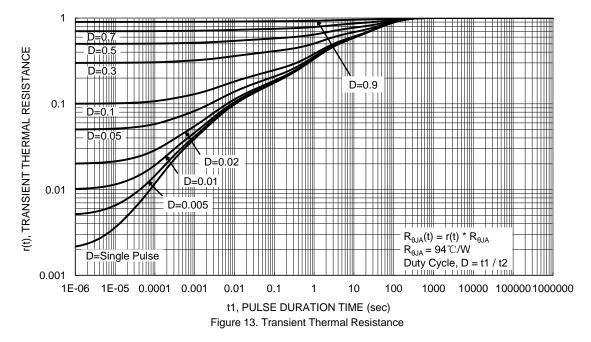


Figure 10. Typical Junction Capacitance





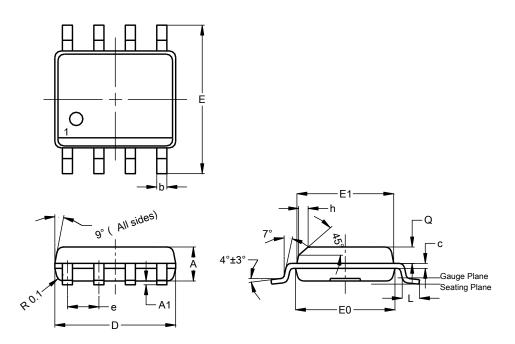




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

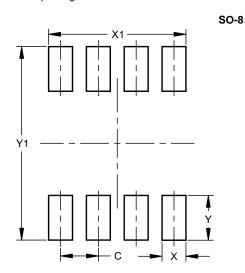
SO-8



SO-8							
Dim	Min	Тур.					
Α	1.40	1.50	1.45				
A1	0.10	0.20	0.15				
b	0.30	0.50	0.40				
C	0.15	0.25	0.20				
D	4.85	4.95	4.90				
Е	5.90	6.10	6.00				
E1	3.80	3.90	3.85				
E0	3.85	3.95	3.90				
e		-	1.27				
h			0.35				
L	0.62	0.82	0.72				
Q	0.60	0.70	0.65				
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



 Dimensions
 Value (in mm)

 C
 1.27

 X
 0.802

 X1
 4.612

 Y
 1.505

 Y1
 6.50

DMP2040USS	
Document number: DS40054 Rev. 4 - 2	



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